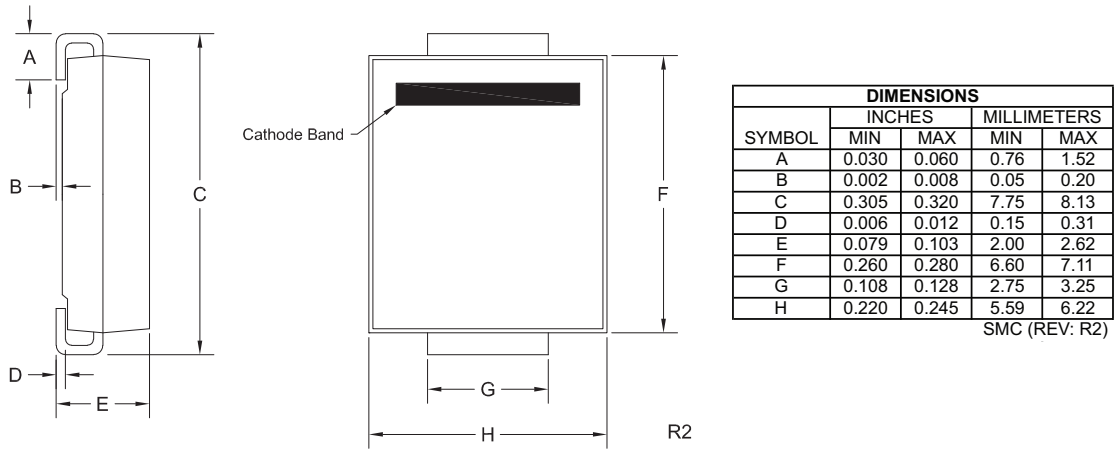


Package Details

SMC Case



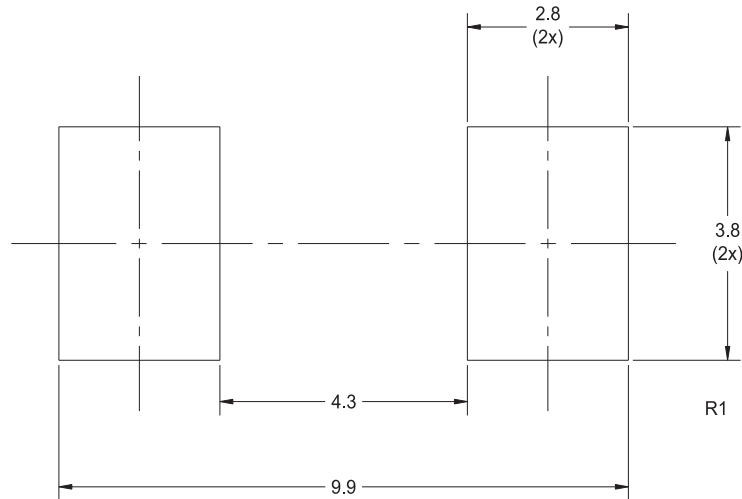
Mechanical Drawing



Lead Code:
Reference individual device datasheet.

Part Marking: 3-6 Character Alpha/Numeric Code

Mounting Pad Geometry (Dimensions in mm)



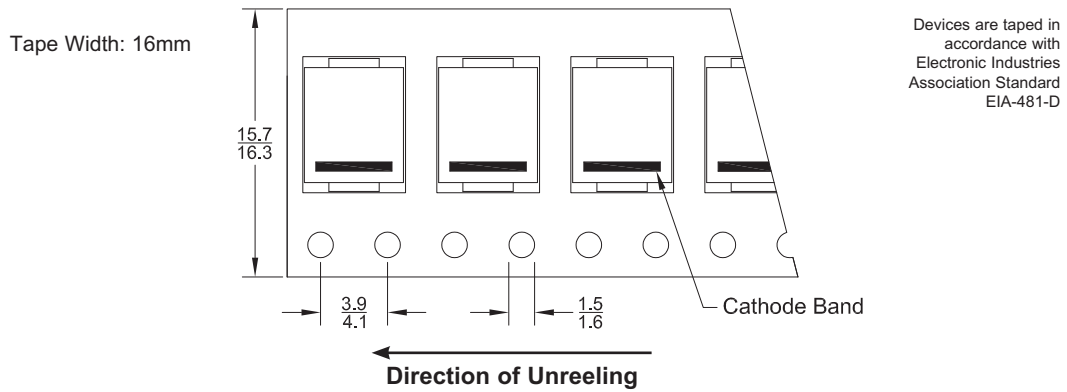
R3 (26-November 2013)

Package Details

SMC Case



Tape Dimensions and Orientation (Dimensions in mm)



Packaging Base

13" Reel = 3,000 pcs.

Reel Labeling Information

Each reel is labeled with the following information:

Central Part Number, Customer Part Number, Purchase Order Number, Quantity, Lot Number, Date Code and Ship Date.

Reel Packing Information

Reel Size	Reels per Box (Maximum)	Parts per Box (Maximum)	Box Dimensions		Shipping Weight (Max.)	
			INCH	CM	LB	KG
13"	4	12,000	15x4x15	38x10x38	12	6
	9	27,000	15x15x9	38x38x23	25	12
	18	54,000	15x15x18	38x38x46	49	23

Ordering Information

- For devices taped and reeled on 13" reels, add TR13 suffix to part number.
- All SMDs are available in small quantities for prototype and manual placement applications.

R3 (26-November 2013)

Material Composition Specification

SMC Case



Device average mass 232.5 mg
 Fluctuation margin +/-10%

Component	Material	Material		Substance	CAS No.	Substance		
		(%wt)	(mg)			(%wt)	(mg)	(ppm)
active device	doped Si	1.63%	3.8	Si	7440-21-3	1.63%	3.8	16,344
leadframe	copper	39.11%	90.92	Cu	7440-50-8	39.11%	90.92	391,054
die attach	high temperature solder paste	1.88%	4.36	Pb	7439-92-1	1.73%	4.033	17,346
				Sn	7440-31-5	0.09%	0.218	938
				Ag	7440-22-4	0.05%	0.109	469
encapsulation*	EMC	56.77%	132	silica	7631-86-9	38.61%	89.76	386,065
				epoxy resin	29690-82-2	11.35%	26.4	113,548
				phenol resin	9003-35-4	5.68%	13.2	56,774
				Sb ₂ O ₃	1309-64-4	0.57%	1.32	5,677
				Br	7726-95-6	0.57%	1.32	5,677
	EMC GREEN	56.77%	132	silica (fused)	60676-86-0	43.72%	101.64	437,161
				epoxy resin	29690-82-2	5.68%	13.2	56,774
				phenol resin	9003-35-4	5.51%	12.804	55,071
				carbon black	1333-86-4	0.17%	0.396	1,703
				metal hydroxide	1309-42-8	1.7%	3.96	17,032
plating**	tin/lead process	0.61%	1.42	Sn	7440-31-5	0.49%	1.136	4,886
				Pb	7439-92-1	0.12%	0.284	1,222
	matte tin	0.61%	1.42	Sn	7440-31-5	0.61%	1.42	6,108

*EMC GREEN molding compound is Halogen-Free.

**For Lead Free plating, add suffix "PB FREE" to part number.

For Tin/Lead plating, add suffix "TIN/LEAD" to part number.

No suffix designation allows for the supply of either lead-free or tin/lead plated product depending on availability.

Disclaimer

The information provided in this Material Composition data sheet is, to the best of our knowledge, correct. However, there is no guarantee to completeness or accuracy, as some information is derived from data sources outside the company.

R6 (16-July 2018)